

Model	No.:
Date /	Rev

FYLS-0603UWC65-5mA

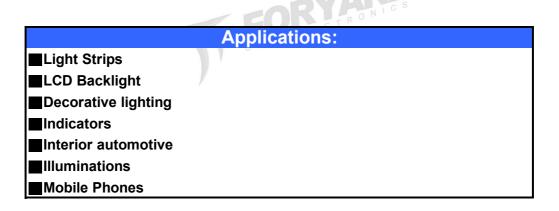
2021.01.23 / B

PRODUCT SPECIFICATION

Model No.: FYLS-0603UWC65-5mA

Features:

SMD Type	
Size (mm):1.60*0.80*0.80	
Emitting Color: White.	
Lens Color: Yellow Diffused.	
SMT package	
Suitable for all SMT assembly and soldering method	
Pb-free Reflow soldering application	
RoHS Compliant	
MSL:4	





CUSTOMER APPROVED SIGNATURES	APPROVED BY	CHECKED BY	PREPARED BY

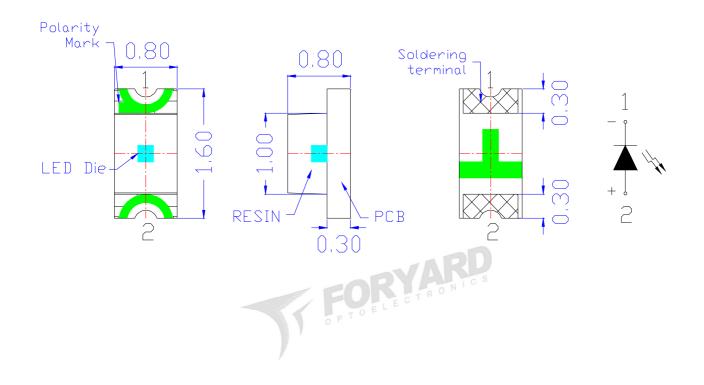
NINGBO FORYARD OPTOELECTRONICS CO., LTD.

Add:No. 666 Jinghua Road, Hi-tech Park, Ningbo, Zhejiang, China Tel: 0086-574-87933652 87927870 87922206 Fax: 0086-574-87927917 E-mail:Sales@foryard.com (General) **Zip:**315103

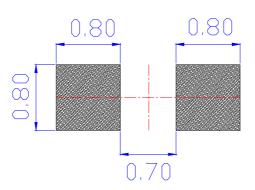


Model No.:	FYLS-0603UWC65-5mA
Date / Rev.	2021.01.23 / B

Mechanical Dimensions



Recommend Soldering pad design(unit=mm)



Notes:

1. Dimension in millimeter, tolerance is ± 0.10 .

2.Angle:±5°

3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

4. The drawing is different from the actual one, please refer to the sample.



Model No.:	FYLS-0603UWC65-5mA
Date / Rev.	2021.01.23 / B

■ Absolute Maximun Ratings(Ta=25°C)

Parameter	Symbol	MAX.	Unit
Power Dissipation	PD	100	mW
Peak Forward Current*	IFP	100	mA
Continuous Forward Current	IF	30	mA
Reverse Voltage	VR	5	V
Operating Temperature Range	Topr	-40~ +85	°C
Storage Temperature Range	Tstg	-40~ +85	°C

*1/10 Duty Cycle, 0.1ms Pulse Width

■ Typical Electrical &Optical Charcteristics(Ta=25°C)

Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Forward Voltage	V _F	IF=5mA	2.5	2.9	3.3	V
Reverse Current	I _R	VR=5V			10	μA
Chromaticity coordinates	Х	IF=5mA		0.31		
	Y	IF=5mA		0.31		
Color temperature	CCT	IF=5mA		6500		К
Luminous Intensity	IV	IF=5mA	145	180	285	mcd
Viewing Angle	2θ _{1/2}	0 ^E IF=5mA		130		Deg
Material				•		

Material

Item	Reflector	Wire	Encapsulate	Chip
Material	/	Gold	Ероху	InGaN/GaN

Note:

1.Luminous Intensity is based on the Foryard standards.

2.Pay attention about static for InGaN

The Luminous Intensity Grade of Products(Unit: mcd) ;Test Condition : If=5mA,Ta=25°C

Code	L2	M1	M2
Luminous Intensity(mcd)	145~180	180~225	225~285

Tolerance of measurement of luminous intensity is ±15%

■Forward Voltage Grade of Products (Unit: V); Test Condition: If=5mA,Ta=25℃

Code	12	13	14	15	16	17	18	19
Forward Voltage(V)	2.5~2.6	2.6-2.7	2.7~2.8	2.8~2.9	2.9~3.0	3.0~3.1	3.1~3.2	3.2~3.3

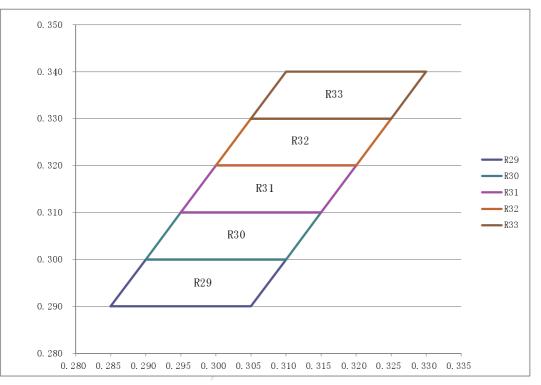
Tolerance of measurement of forward voltage is ±0.1V



Model No.:	FYLS-0603UWC65-5mA
Date / Rev.	2021.01.23 / B

Chromaticity Coordinate Grade of White Chip-LED Products

Test Condition:@IF=5mA Ta=25℃

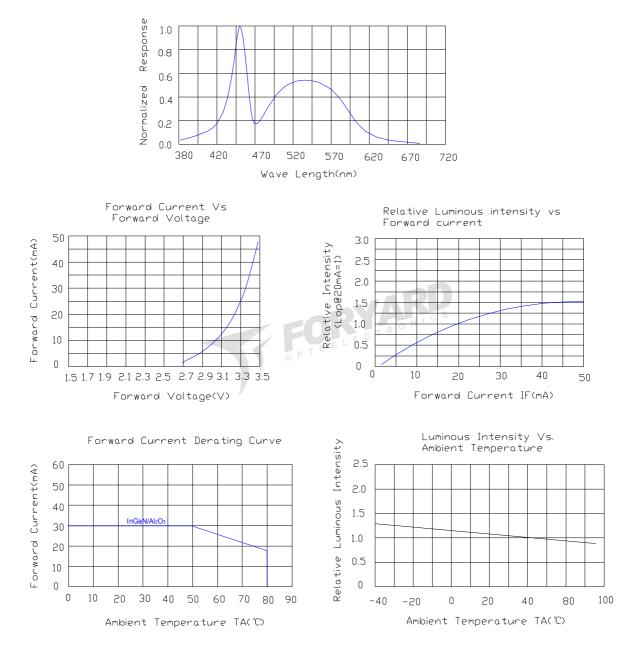


BIN	CIE	Тор	Right	Bottom	Left
R00	Х	0. 285	0.290	0.310	0.305
R29	Y	0.290	0.300	0.300	0.290
D 20	Х	0.290	0. 295	0.315	0.310
R30	Y	0.300	0.310	0.310	0.300
D01	Х	0.295	0.300	0.320	0.315
R31	Y	0.310	0.320	0.320	0.310
D 20	Х	0.300	0. 305	0 . 325	0. 320
R32	Y	0.320	0.330	0.330	0.320
DOO	Х	0.305	0.310	0.330	0. 325
R33	Y	0.330	0.340	0.340	0.330



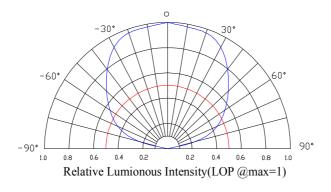
Model No.:	FYLS-0603UWC65-5mA	
Date / Rev.	2021.01.23 / B	

Electrical-Optical Characteristics-





Radiation pattern-

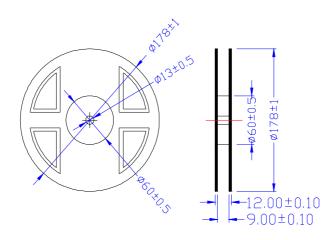




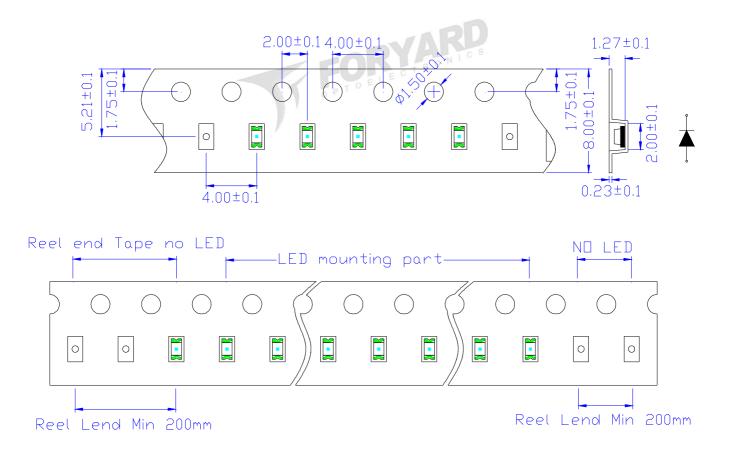
Model No.:	FYLS-0603UWC65-5mA	
Date / Rev.	2021.01.23 / B	

Package-

1. Reel Dimension



2. Tape Dimension



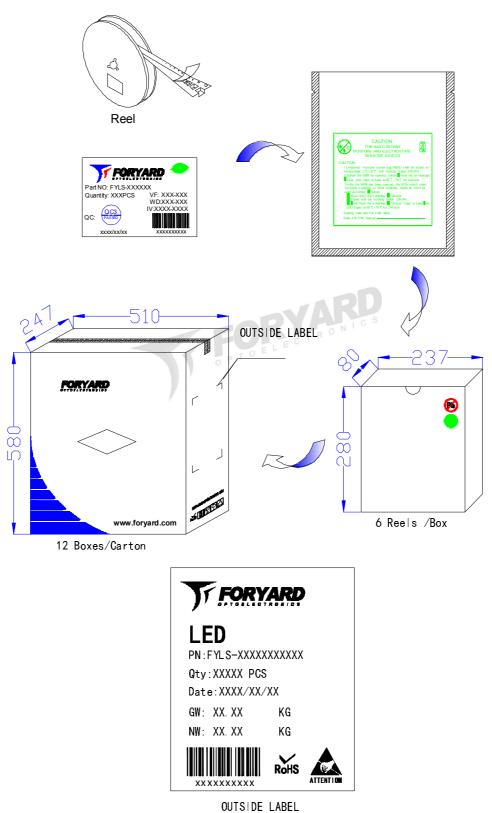
Notice:

1. Tolerance unless mentioned is \pm 0.2mm



Мо	odel No.:	FYLS-0603UWC65-5mA	
D	ate / Rev.	2021.01.23 / B	

3.Packing Diagram



Notice:

1.Quantity:4000 PCS/Reel

2. The specifications are subject to change without notice. Please contact us for updated information.

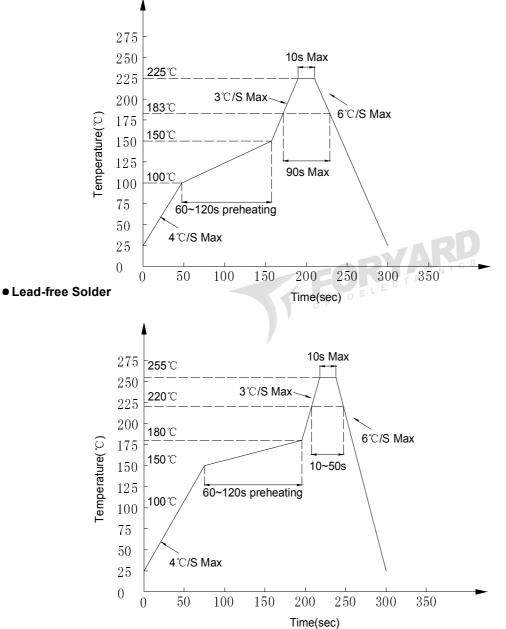


Model No.:	FYLS-0603UWC65-5mA
Date / Rev.	2021.01.23 / B

Soldering Characteristics-

Reflow Soldering

Lead Solder



Notes:

1.Although the recommended soldering conditions are specified in above table, reflow or hand soldering at the lowest possible temperature is desired for the LEDs.

2.A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.

3.All temperatures refer to solder Pad.

Hand Soldering

Soldering temperature	300℃ Max. (25W Max.)	One time olny
Soldering time	5 ±1sec	One time only



Model No.:	FYLS-0603UWC65-5mA	
Date / Rev.	2021.01.23 / B	

Handling of Silicone Resin LEDs-

Handling Indications

When handling the product, do not touch it directly with bare hands as it may contaminate the surface and affect on optica characteristics. In the worst cases, excessive force to the product might result in catastrophic failure due to package damage and/or wire breakage.



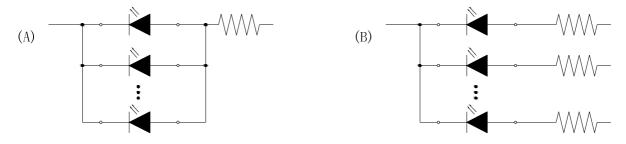
When handling the product with tweezers,LEDs should only be handled from the side and make sure that excessive force is not applied to the resin portion of the pordct. Failure to comply can cause the resin portion of the product to be cut,chipped,delaminated and/or deformed, and wire to be broken, and thus resulting in catastrophic failure.





Recommended circuit-

• In designing a circuit, the current through each LED must not exceed the absolute maximum rating specified for each LEC It is recommended to use Circuit B which regulates the current flowing through each LED. In the meanwhile, when driving LE with a constant voltage in Circuit A, the current through the LEDs may vary due to the variation in forward voltage(VF) of the LEDs. In the worst case, some LED may be subjected to stresses in excess of the absolute maximum rating.



• This product should be operated in forward bias. A driving circuit must be designed so that the product is not subjected to either forward or reverse voltage while it is off. In particular, if a reverse voltage is continuously applied to the product; such operation can cause migration resulting in LED damage.

Storage-

Storage Conditions

1.Unopened moisture barrier bag (MBB) shall be stored at temperature below $5^{\circ}C \sim 30^{\circ}C$, with humidity below $60^{\circ}RH$. 2.Before the MBB be opened, check if have the air leakage, if have, then need to bake at $65^{\circ}C \sim 70^{\circ}C$ for 24 hours.

3.After the MBB has been opened, the LEDs which need for reflow soldering or other soldering methods, must be used

according to below:

- a: Must finish the soldering in 72hours
- b: Stored with the humidity below 30%RH
- c: If not finish the soldering in 72hours, need to bake the LED again at $65\,^\circ\!C$ ~70 $^\circ\!C$ for 24hours